

**Gate resistor installed
Dual N-channel MOSFET**

**KFC4B22180L
Data Sheet**

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1. GENERAL DESCRIPTION

Gate resistor installed Dual N-channel MOSFET
For lithium-ion secondary battery protection circuits

2. FEATURES

- Low source-source ON resistance: RSS (on) typ. = 9.4 mΩ (VGS = 4.5 V)
- CSP (Chip Size Package)
- RoHS compliant (EU RoHS / MSL: Level 1 compliant)

3. MARKING SYMBOL: 17

4. PACKAGING

Embossed type (Thermo-compression sealing): 10,000 pcs / reel (standard)

5. ABSOLUTE MAXIMUM RATINGS $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Source-source Voltage	VSS	20	V
Gate-source Voltage	VGS	± 8	V
Source Current	DC	IS1 *1	5
		IS2 *2	10
	Pulsed	ISp *3	50
Total Power Dissipation	DC	PD1 *1	0.4
		PD2 *2	1.5
Channel Temperature	Tch	150	$^\circ\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^\circ\text{C}$

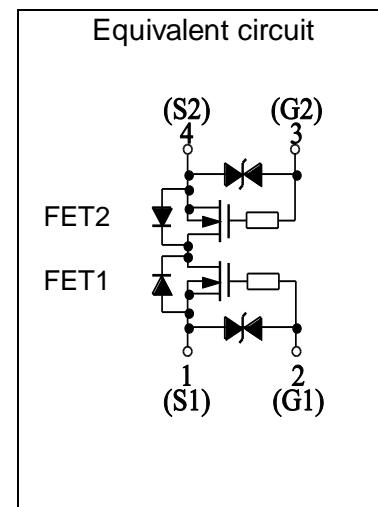
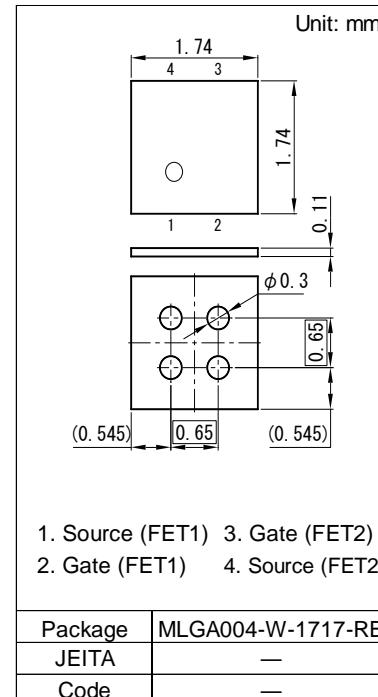
6. THERMAL CHARACTERISTICS $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Thermal Resistance (ch-a)	Rth1 *1	312	$^\circ\text{C} / \text{W}$
	Rth2 *2	83	

Note *1 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm)
using the minimum recommended pad size (36 μm Copper).

*2 Mounted on Ceramic substrate (70 mm x 70 mm x t1.0 mm).

*3 t = 10 μs , Duty Cycle $\leq 1\%$



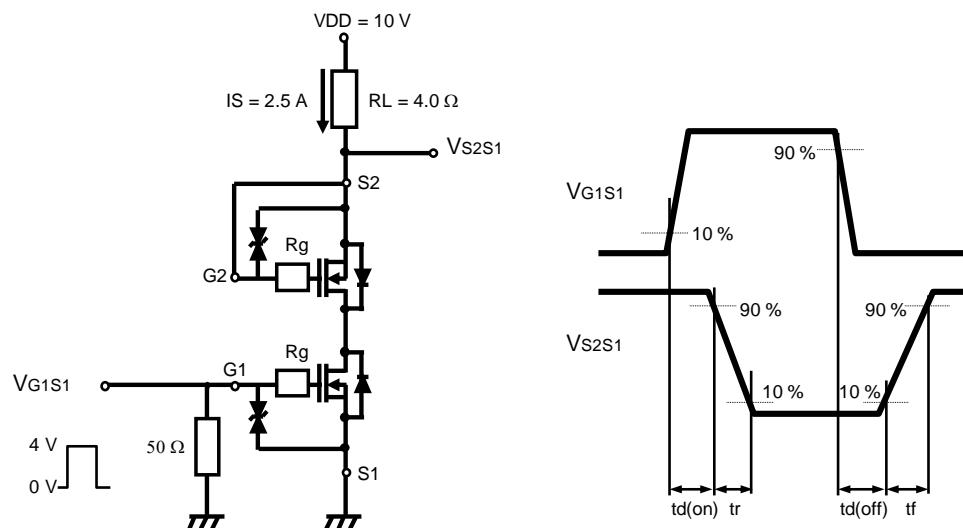
7. ELECTRICAL CHARACTERISTICS $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Source-source Breakdown Voltage	VSSS	$IS = 1 \text{ mA}, VGS = 0 \text{ V}$	20			V
Zero Gate Voltage Source Current	ISSS	$VSS = 20 \text{ V}, VGS = 0 \text{ V}$			1.0	μA
Gate-source Leakage Current	IGSS1	$VGS = \pm 8 \text{ V}, VSS = 0 \text{ V}$			± 10	μA
	IGSS2	$VGS = \pm 5 \text{ V}, VSS = 0 \text{ V}$			± 1.0	
Gate-source Threshold Voltage	Vth	$IS = 0.64 \text{ mA}, VSS = 10 \text{ V}$	0.35	0.90	1.40	V
Source-source On-state Resistance	RSS(on)1	$IS = 2.5 \text{ A}, VGS = 4.5 \text{ V}$	7.0	9.4	11.9	$\text{m}\Omega$
	RSS(on)2	$IS = 2.5 \text{ A}, VGS = 3.8 \text{ V}$	7.3	10.0	12.9	
	RSS(on)3	$IS = 2.5 \text{ A}, VGS = 3.1 \text{ V}$	8.1	11.1	15.8	
	RSS(on)4	$IS = 2.5 \text{ A}, VGS = 2.5 \text{ V}$	8.6	13.4	22.6	
Body Diode Forward Voltage	VF(s-s)	$IF = 2.5 \text{ A}, VGS = 0 \text{ V}$		0.8	1.2	V
Input Capacitance ^{*1}	Ciss	$VSS = 10 \text{ V}, VGS = 0 \text{ V}, f = 1 \text{ kHz}$		2440		pF
Output Capacitance ^{*1}	Coss			200		
Reverse Transfer Capacitance ^{*1}	Crss			160		
Turn-on Delay Time ^{*1,*2}	td(on)	$VDD = 10 \text{ V}, VGS = 0 \text{ to } 4 \text{ V}$		0.9		μs
Rise Time ^{*1,*2}	tr		$IS = 2.5 \text{ A}$	1.6		
Turn-off Delay Time ^{*1,*2}	td(off)	$VDD = 10 \text{ V}, VGS = 4 \text{ to } 0 \text{ V}$		5.0		μs
Fall Time ^{*1,*2}	tf		$IS = 2.5 \text{ A}$	2.4		
Total Gate Charge ^{*1}	Qg	$VDD = 10 \text{ V}$		23		nC
Gate-source Charge ^{*1}	Qgs		$VGS = 0 \text{ to } 4 \text{ V}$	6		
Gate-drain Charge ^{*1}	Qgd		$IS = 2.5 \text{ A}$	5		

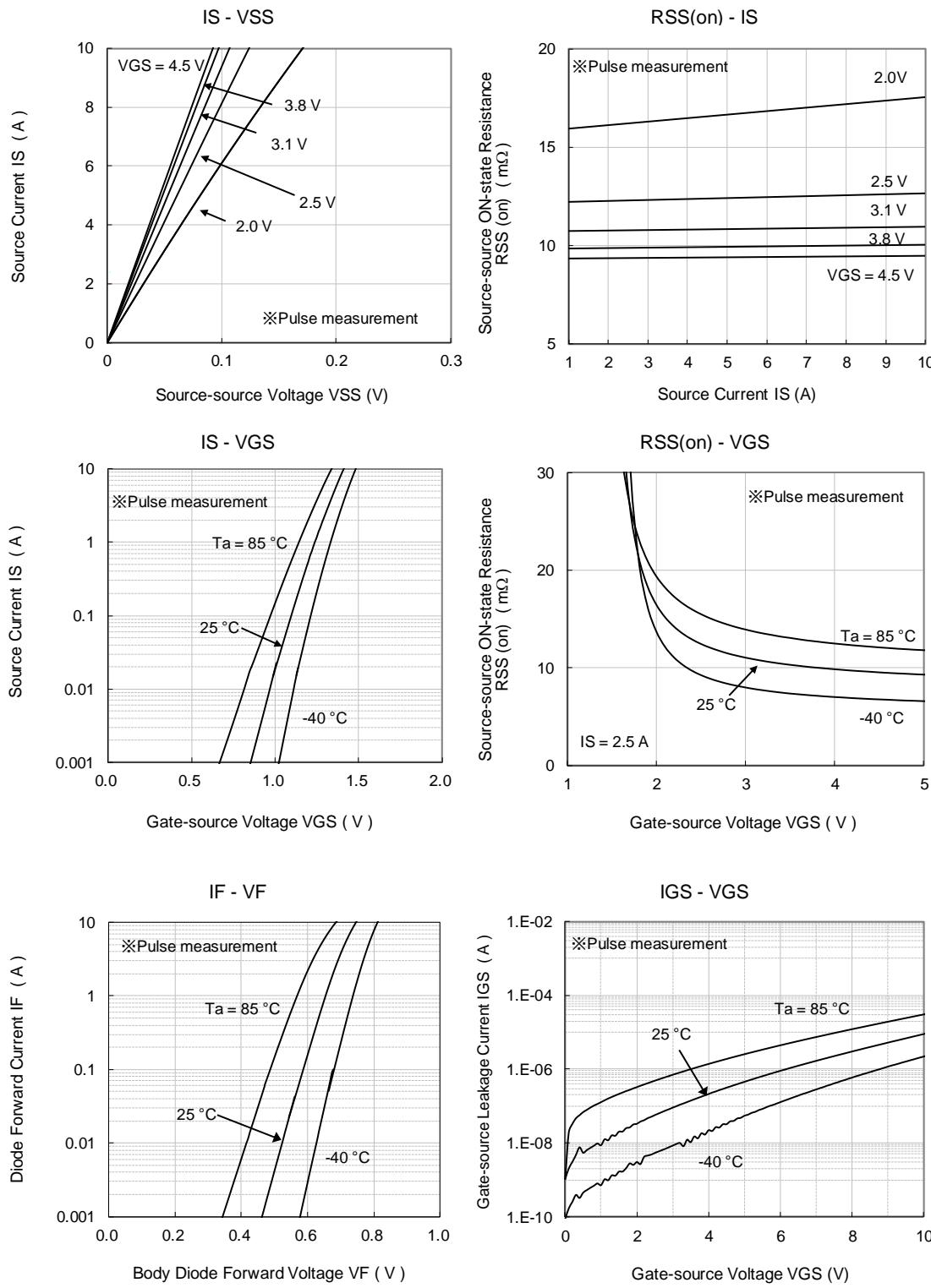
Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

^{*1} Guaranteed by design, not subject to production testing

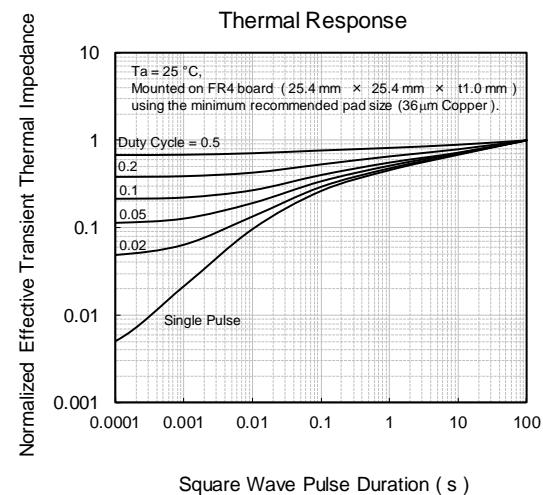
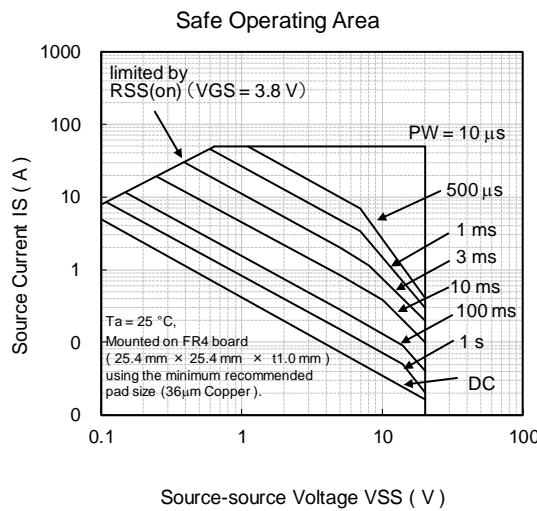
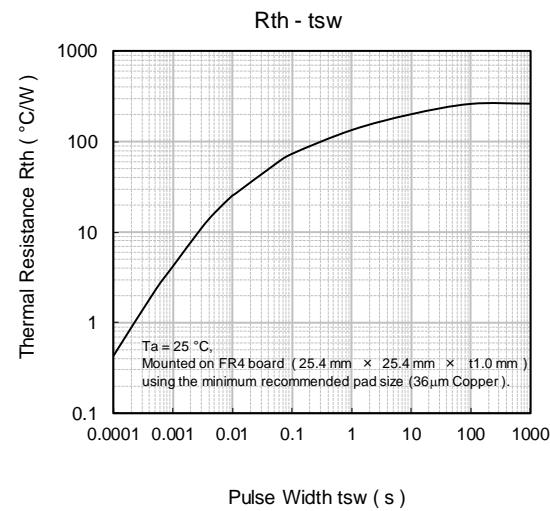
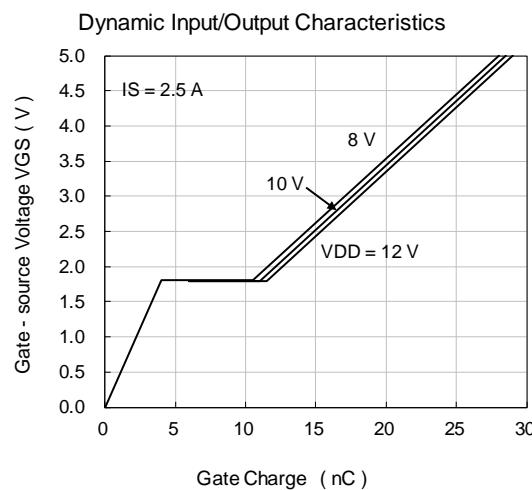
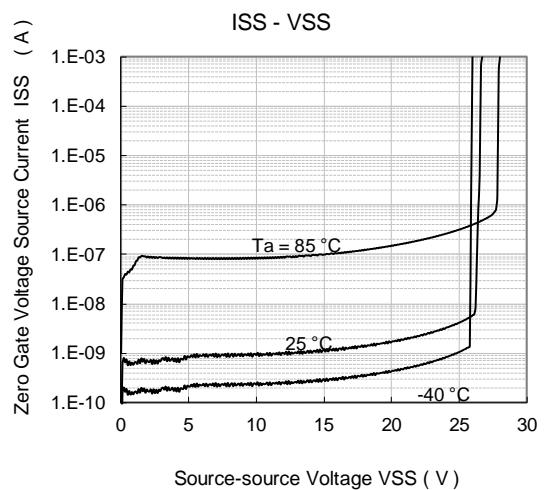
^{*2} Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time



8. TECHNICAL DATA (Reference)

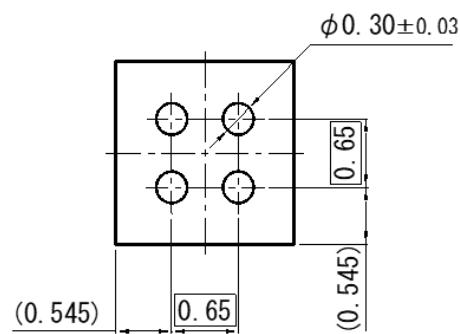
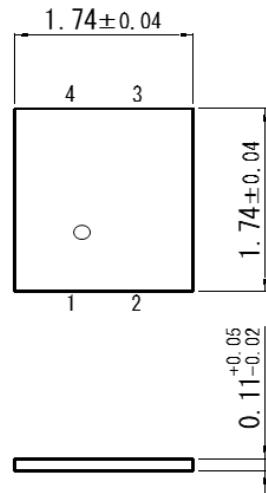


TECHNICAL DATA (Reference)



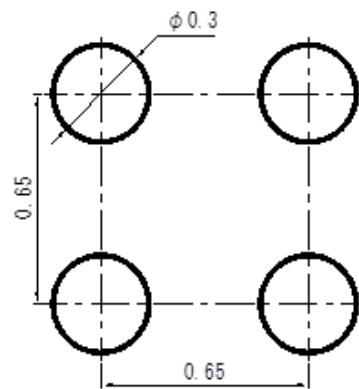
9. OUTLINE

Unit : mm



10. LAND PATTERN (Reference)

Unit: mm



12. REVISION HISTORY

Date	Revision	Description
2021.2.3	1.00	1. initially issued.

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